TPC8209

<u>TOSHIBA</u>

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOS II)

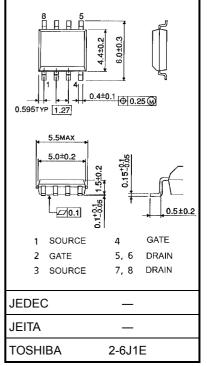
TPC8209

Lithium Ion Battery Applications Portable Equipment Applications Notebook PC Applications

- Small footprint due to small and thin package
- Low drain-source ON resistance: R_{DS} (ON) = 30 m Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 10 \text{ S} (typ.)$
- Low leakage current: $I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 30 \ V)$
- Enhancement-mode: $V_{th} = 1.3$ to 2.5 V ($V_{DS} = 10$ V, $I_D = 1$ mA)

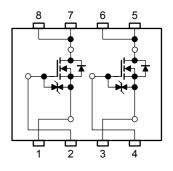
Maximum Ratings (Ta = 25°C)

Char	acteristics	Symbol	Rating	Unit	
Drain-source vol	tage	V _{DSS}	30	V	
Drain-gate voltag	ge (R _{GS} = 20 k Ω)	V _{DGR}	30	V	
Gate-source volt	age	V _{GSS}	±20	V	
Drain current	D C (Note 1)	ID	5	Α	
	Pulse (Note 1)	I _{DP}	20	A .	
Drain power dissipation	Single-device operation (Note 3a)	P _{D (1)}	1.5	W	
(t = 10s) (Note 2a)	Single-device value at dual operation (Note 3b)	P _{D(2)}	1.1		
Drain power dissipation (t = 10s) (Note 2b)	Single-device operation (Note 3a)	P _{D (1)}	0.75	W	
	Single-device value at dual operation (Note 3b)	P _{D (2)}	0.45		
Single pulse ava	lanche energy (Note 4)	E _{AS}	32.5	mJ	
Avalanche curre	nt	I _{AR}	5	A	
Repetitive avalate Single-device va	nche energy lue at dual operation (Note 2a, 3b, 5)	E _{AR}	0.1	mJ	
Channel tempera	ature	T _{ch}	150	°C	
Storage tempera	iture range	T _{stg}	-55~150	°C	



Weight: 0.08 g (typ.)

Circuit Configuration



Note: For (Note 1), (Note 2), (Note 3) and (Note 4), please refer to the next page.

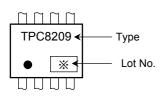
This transistor is an electrostatic sensitive device. Please handle with caution.

Unit: mm

Thermal Characteristics

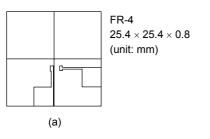
Characteristics	Symbol	Max	Unit		
Thermal resistance, channel to ambient	Single-device operation (Note 2a)	R _{th (ch-a)} (1)	83.3		
(t = 10s) (Note 1a)	Single-device value at dual operation (Note 2b)	R _{th (ch-a) (2)}	114	°C/W	
Thermal resistance, channel to ambient	Single-device operation (Note 2a)	R _{th (ch-a) (1)}	167	C/W	
(t = 10s) (Note 2b)	Single-device value at dual operation (Note 2b)	R _{th (ch-a) (2)}	278		

Marking (Note 6)

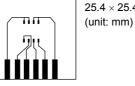


Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2:



a) Device mounted on a glass-epoxy board (a)



FR-4 $25.4\times25.4\times0.8$

(b)

Device mounted on a glass-epoxy board (b) b)

Note 3:

- a) The power dissipation and thermal resistance values are shown for a single device. (During single-device operation, power is only applied to one device.)
- b) The power dissipation and thermal resistance values are shown for a single device. (During dual operation, power is evenly applied to both devices.)

Note 4: V_{DD} = 24 V, T_{ch} = 25°C (initial), L = 1.0 mH, R_G = 25 Ω , I_{AR} = 5 A

Note 5: Repetitive rating: pulse width limited by maximum channel temperature

Note 6: • on lower left of the marking indicates Pin 1.



※ Weekly code: (Three digits) Week of manufacture (01 for first week of year, continues up to 52 or 53) Year of manufacture (One low-order digits of calendar year)

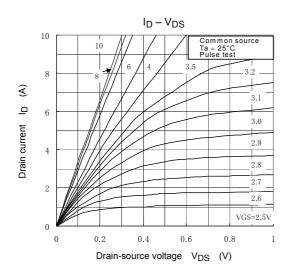
Electrical Characteristics (Ta = 25°C)

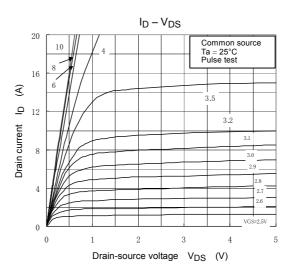
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage current		I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	—	±10	μA	
Drain cut-OFF current		I _{DSS}	V_{DS} = 30 V, V_{GS} = 0 V		_	10	μA	
Drain-source breakdown voltage		V (BR) DSS	I_{D} = 10 mA, V_{GS} = 0 V	30	—	—	v	
Drain Source breaku	own voltage	V (BR) DSS	I_D = 10 mA, V_{GS} = –20 V	15 — — 1.3 — 2.5		v		
Gate threshold voltage		V _{th}	V _{DS} = 10 V, I _D = 1 mA	1.3	_	2.5	V	
Drain-source ON res	istance	R _{DS (ON)}	V _{GS} = 4.0 V, I _D = 2.5 A		43	60	mΩ	
	istance	R _{DS (ON)}	V_{GS} = 10 V, I _D = 2.5 A	30 40 5 10 —		11152		
Forward transfer admittance		Y _{fs}	V _{DS} = 10 V, I _D = 2.5 A	5	10	_	S	
Input capacitance		C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		600	—	pF	
Reverse transfer capacitance		C _{rss}			95	_		
Output capacitance		C _{oss}			160	_		
Switching time	Rise time	tr	$V_{GS} = 2.5 \text{ A}$ $V_{GS} = 2.5 \text{ A}$ $V_{OV} = 0$ $V_{OUT} = 0$ V_{OUT		4	_		
	Turn-ON time	t _{on}			10	_	- ns	
	Fall time	t _f		_	9	_		
	Turn-OFF time	t _{off}	Duty \leq 1%, t _w = 10 μ s	_	35	—		
Total gate charge (Gate-source plus gate-drain)		Qg	V _{DD} ≈ 24 V, V _{GS} = 10 V, I _D = 5 A	_	15	_		
Gate-source charge		Q _{gs}		—	11	—	nC	
Gate-drain ("miller") charge		Q _{gd}		—	4	—		

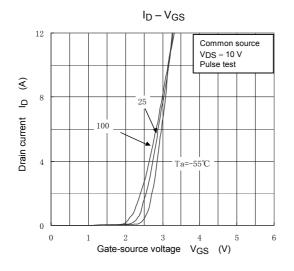
Source–Drain Ratings and Characteristics (Ta = 25°C)

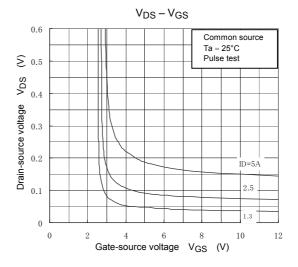
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I _{DRP}	—	_	_	20	А
Forward voltage (diode)		V _{DSF}	I _{DR} = 5 A, V _{GS} = 0 V	_	_	-1.2	V

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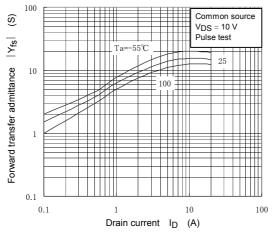




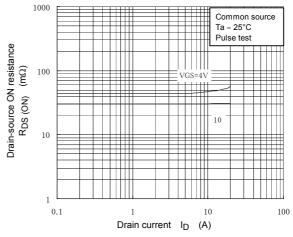




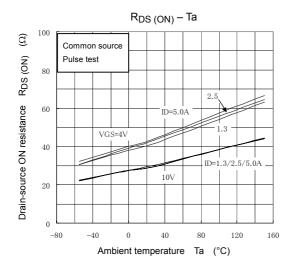


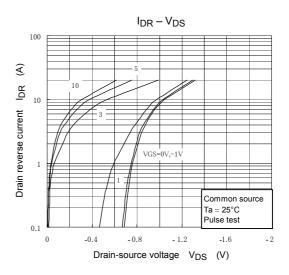


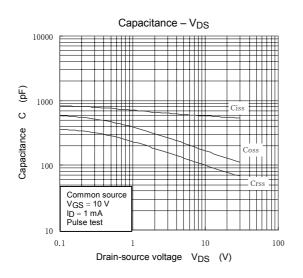
R_{DS (ON)} – I_D

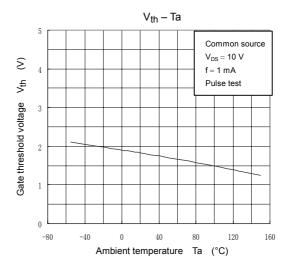


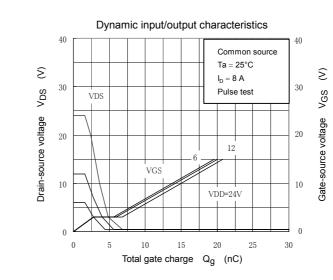
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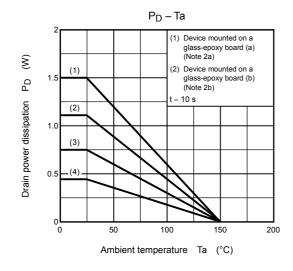


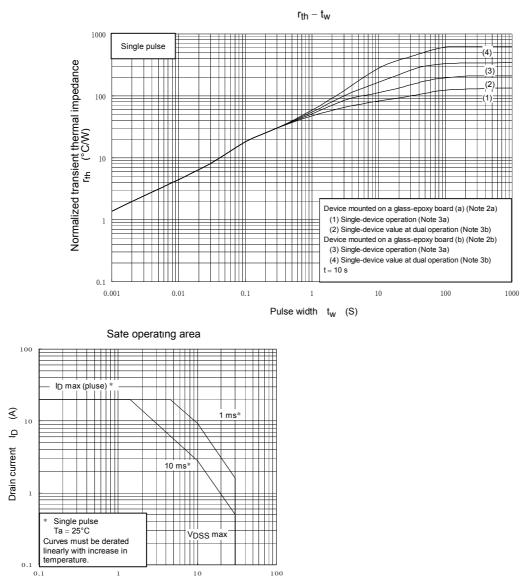












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Drain-source voltage V_{DS} (V)

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